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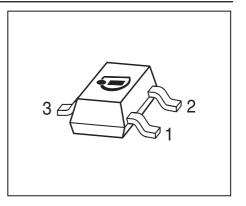


SMBTA42/MMBTA42

NPN Silicon High-Voltage Transistors

- Low collector-emitter saturation voltage
- Complementary types: SMBTA92 / MMBTA92(PNP)
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101





Туре	Marking	Pin Configuration			Package
SMBTA42/MMBTA42	s1D	1=B	2=E	3=C	SOT23

Maximum Ratings

Parameter	Symbol	Value	Unit	
Collector-emitter voltage	V _{CEO}	300	V	
Collector-base voltage	V _{CBO}	300		
Emitter-base voltage	V _{EBO}	6		
Collector current	Ι _C	500	mA	
Base current	I _B	100		
Total power dissipation-	P _{tot}	360	mW	
<i>T</i> _S ≤ 74 °C				
Junction temperature	Tj	150	°C	
Storage temperature	T _{stq}	-65 150		

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R _{thJS}	≤ 210	K/W

¹For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)



Parameter	Symbol		Values	1	Unit
			typ.	max.	
DC Characteristics			1	1	1
Collector-emitter breakdown voltage	V _{(BR)CEO}	300	-	-	V
$I_{\rm C} = 1 {\rm mA}, I_{\rm B} = 0$					1
Collector-base breakdown voltage	V _{(BR)CBO}	300	-	-	
$I_{\rm C}$ = 100 µA, $I_{\rm E}$ = 0					
Emitter-base breakdown voltage	V _{(BR)EBO}	6	-	-	
$I_{\rm E}$ = 100 µA, $I_{\rm C}$ = 0					
Collector-base cutoff current	I _{CBO}				μA
$V_{\rm CB}$ = 200 V, $I_{\rm E}$ = 0		-	-	0.1	
$V_{\rm CB}$ = 200 V, $I_{\rm E}$ = 0 , $T_{\rm A}$ = 150 °C		-	-	20	
Emitter-base cutoff current	I _{EBO}	-	-	100	nA
$V_{\rm EB}$ = 5 V, $I_{\rm C}$ = 0					
DC current gain ¹⁾	h _{FE}				-
<i>I</i> _C = 1 mA, <i>V</i> _{CE} = 10 V		25	-	-	
<i>I</i> _C = 10 mA, <i>V</i> _{CE} = 10 V		40	-	-	
<i>I</i> _C = 30 mA, <i>V</i> _{CE} = 10 V		40	-	-	
Collector-emitter saturation voltage ¹⁾	V _{CEsat}	-	-	0.5	V
<i>I</i> _C = 20 mA, <i>I</i> _B = 2 mA					
Base emitter saturation voltage ¹⁾	V _{BEsat}	-	-	0.9	
<i>I</i> _C = 20 mA, <i>I</i> _B = 2 mA					
AC Characteristics					
Transition frequency	f _T	50	70	-	MHz
$I_{\rm C}$ = 10 MHz, $V_{\rm CE}$ = 20 V, f = 100 MHz					
Collector-base capacitance	C _{cb}	-	-	3	pF
			1		1

	0500			
Electrical Characteristics at T_{Δ}	= 25°C,	uniess	otherwise	specified

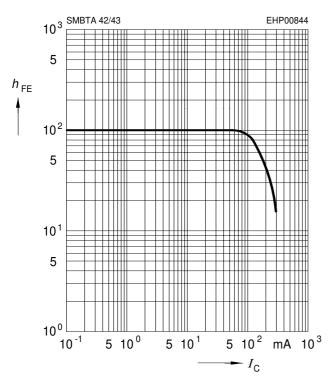
¹Pulse test: t < 300 μ s; D < 2%

 V_{CB} = 20 V, f = 1 MHz

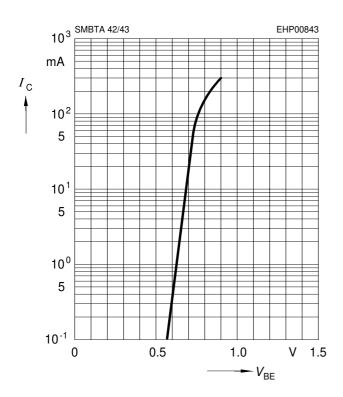


DC current gain $h_{\text{FE}} = f(I_{\text{C}})$

*V*_{CE} = 10 V

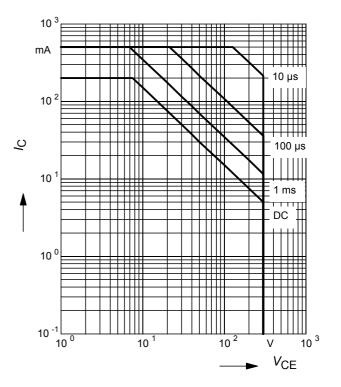






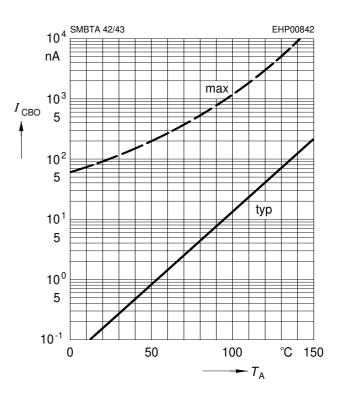
Operating range $I_{\rm C}$ = $f(V_{\rm CEO})$

 $T_{\rm A} = 25^{\circ}{\rm C}, D = 0$



Collector cutoff current $I_{CBO} = f(T_A)$

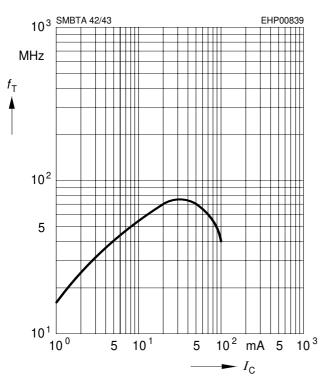
 $V_{\rm CBO}$ = 160 V





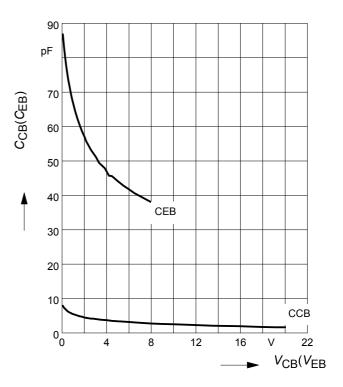
Transition frequency $f_{\rm T} = f(I_{\rm C})$

*V*_{CE} = 10 V, *f* = 100 MHz

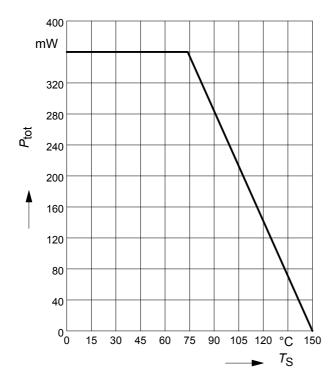


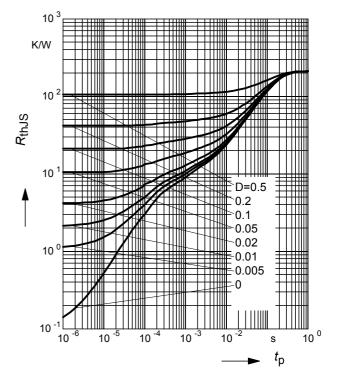
Total power dissipation $P_{tot} = f(T_S)$





Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$

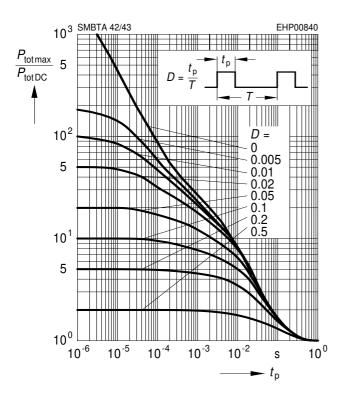




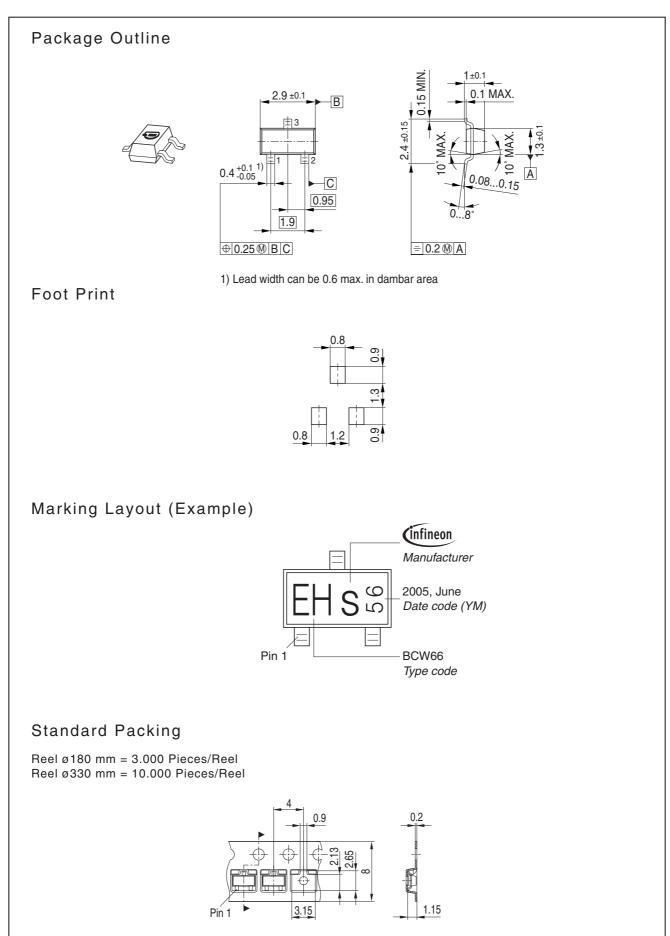


Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{\text{p}})$









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